General Description

The MAX3221E/MAX3223E/MAX3243E are 3V-powered EIA/TIA-232 and V.28/V.24 communications interfaces with automatic shutdown/wakeup features, high data-rate capabilities, and enhanced electrostatic discharge (ESD) protection. All transmitter outputs and receiver inputs are protected to ± 15 kV using IEC 1000-4-2 Air-Gap Discharge, to ± 8 kV using IEC 1000-4-2 Contact Discharge, and to ± 15 kV using the Human Body Model.

The MAX3221E/MAX3223E/MAX3243E achieve a 1µA supply current with Maxim's revolutionary AutoShutdown[™] feature. They save power without changes to the existing BIOS or operating system by entering low-power shutdown mode when the RS-232 cable is disconnected, or when the transmitters of the connected peripherals are off.

The transceivers have a proprietary low-dropout transmitter output stage, delivering true RS-232 performance from a +3.0V to +5.5V supply with a dual charge pump. The charge pump requires only four small 0.1 μ F capacitors for operation from a +3.3V supply. Each device is guaranteed to run at data rates of 250kbps while maintaining RS-232 output levels.

The MAX3221E contains just one driver and one receiver, making it the smallest single-supply RS-232 transceiver. The MAX3223E has two drivers and two receivers. The MAX3243E is a complete 3-driver/5-receiver serial port ideal for notebook or subnotebook computers. It also includes two noninverting receiver outputs that are always active, allowing external devices to be monitored without forward biasing the protection diodes in circuitry that may be powered down.

The MAX3221E, MAX3223E, and MAX3243E are available in space-saving TQFN, SSOP, and TSSOP packages.

Applications

Notebook, Subnotebook, and Palmtop Computers Cellular Phones Battery-Powered Equipment Handheld Equipment Peripherals Printers

Pin Configurations appear at end of data sheet. Typical Operating Circuits appear at end of data sheet.

AutoShutdown and UCSP are trademarks of Maxim Integrated Products, Inc.

†Covered by U.S. Patent numbers 4,636,930; 4,679,134; 4,777,577; 4,797,899; 4,809,152; 4,897,774; 4,999,761; 5,649,210; and other patents pending.

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Next Generation Device Features

- ♦ For Space-Constrained Applications: MAX3228E/MAX3229E: ±15kV ESD-Protected, +2.5V to +5.5V RS-232 Transceivers in UCSP™ MAX3222E/MAX3232E/MAX3237E/MAX3241E/ MAX3246E: ±15kV ESD-Protected Down to 10nA, +3.0V to +5.5V, Up to 1Mbps, True RS-232 Transceivers (MAX3246E Available in a UCSP Package)
- ♦ For Data Cable Applications: MAX3380E/MAX3381E: +2.35V to +5.5V, 1µA, 2Tx/2Rx RS-232 Transceivers with ±15kV ESD-Protected I/O and Logic Pins

_Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX3221ECTE+	0°C to +70°C	16 TQFN-EP*
MAX3221ECUE+	0°C to +70°C	16 TSSOP
MAX3221ECAE+	0°C to +70°C	16 SSOP
MAX3221EEAE+	-40°C to +85°C	16 SSOP
MAX3221EETE+	-40°C to +85°C	16 TQFN-EP*
MAX3221EEUE+	-40°C to +85°C	16 TSSOP
MAX3223ECPP+	0°C to +70°C	20 PDIP
MAX3223ECAP+	0°C to +70°C	20 SSOP
MAX3223ECUP+	0°C to +70°C	20 TSSOP
MAX3223ECTP+	0°C to +70°C	20 TQFN-EP*
MAX3223EEPP+	-40°C to +85°C	20 PDIP
MAX3223EEAP+	-40°C to +85°C	20 SSOP
MAX3223EEUP+	-40°C to +85°C	20 TSSOP
MAX3223EETP+	-40°C to +85°C	20 TQFN-EP*
MAX3223EEUP/V+	-40°C to +85°C	20 TSSOP
*Exposed pad		

*Exposed pad.

+Denotes a lead(Pb)-free/RoHS-compliant package. N denotes an automotive qualified part.

Ordering Information continued at end of data sheet.

Selector Guide

PART	NO. OF DRIVERS/ RECEIVERS	VCC RANGE (V)	AutoShutdown
MAX3221E	1/1	+3.0 to +5.5	~
MAX3223E	2/2	+3.0 to +5.5	~
MAX3243E	3/5	+3.0 to +5.5	~

Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

ABSOLUTE MAXIMUM RATINGS

V _{CC} to GND0.3V to +6V V+ to GND (Note 1)0.3V to +7V V- to GND (Note 1)+0.3V to -7V V+ + V- (Note 1)+13V	
Input Voltages	
T_IN, EN, FORCEON, FORCEOFF to GND0.3V to +6V R_IN to GND±25V	
Output Voltages	
T_OUT to GND±13.2V	
R_OUT, R2OUTB, INVALID to GND0.3V to (V _{CC} + 0.3V)	
Short-Circuit Duration	
T_OUT to GNDContinuous	
Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
16-Pin SSOP (derate 7.14mW/°C above +70°C)571mW 16-Pin TSSOP (derate 9.4mW/°C above +70°C)754.7mW	

16-Pin TQFN (derate 20.8mW/°C above +70°C)1666.7mW
20-Pin Plastic DIP (derate 11.11mW/°C above +70°C)889mW
20-Pin SSOP (derate 8.00mW/°C above +70°C)640mW
20-Pin TSSOP (derate 10.9mW/°C above +70°C)879mW
20-Pin TQFN (derate 21.3mW/°C above +70°C)1702.1mW
28-Pin SSOP (derate 9.52mW/°C above +70°C)762mW
28-Pin TSSOP (derate 12.8mW/°C above +70°C)1026mW
32-Pin TQFN (derate 37mW/°C above +70°C)
Operating Temperature Ranges
MAX32EC0°C to +70°C
MAX32EE40°C to +85°C
Storage Temperature Range65°C to +160°C
Lead Temperature (soldering, 10s)+300°C
Soldering Temperature (reflow)+260°C

Note 1: V+ and V- can have maximum magnitudes of 7V, but their absolute difference cannot exceed 13V.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{CC} = +3.0V \text{ to } +5.5V, C1-C4 = 0.1\mu F \text{ (Note 2)}, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted}. Typical values are at T_A = +25°C.)$

PARAMETER	SYMBOL	CONDITIONS			MIN	ТҮР	MAX	UNITS
DC CHARACTERISTICS (V _{CC} =	3.3V or 5.0V	$T_{A} = +25^{\circ}C$						
Supply Current, AutoShutdown		FORCEON = FORCEOFF =	-)	R_IN open		1.0	10	μA
Supply Current, Shutdown		FORCEOFF =	GND, all	$R_IN = GND$		1.0	10	μΑ
Supply Current, AutoShutdown Disabled		FORCEON = no load	FORCEO	FF = V _{CC} ,		0.3	1	mA
LOGIC INPUTS								
Input Logic Threshold Low		T_IN, EN, FOF	RCEON, F	ORCEOFF			0.8	V
Input Logic Threshold High		T_IN, EN, FORCEON,		$V_{CC} = 3.3V$	2.0			V
Input Logic Thieshold High		FORCEOFF		$V_{CC} = 5.0V$	2.4			
Transmitter Input Hysteresis						0.5		V
Input Leakage Current		T_IN, EN, FOF	RCEON, F	ORCEOFF		±0.01	±1	μΑ
RECEIVER OUTPUTS								
Output Leakage Current		R_OUT receiv	ers disab	led		±0.05	±10	μΑ
Output Voltage Low		$I_{OUT} = 1.6 mA$					0.4	V
Output Voltage High		I _{OUT} = -1.0m/	4		V _{CC} - 0.6	V _{CC} - 0.1		V
AutoShutdown (FORCEON = G	ND, FORCEC	$\overline{FF} = V_{CC}$			1			
Receiver Input Threshold to		Figure 5a	Positive	threshold			2.7	V
INVALID Output High		Figure 5a	Negative	e threshold	-2.7			
Receiver Input Threshold to INVALID Output Low		Figure 5a			-0.3		0.3	V
INVALID Output Voltage Low		I _{OUT} = 1.6mA					0.4	V
INVALID Output Voltage High		IOUT = -1.0mA	Ą		Vcc - 0.6			V

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ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC} = +3.0V \text{ to } +5.5V, C1-C4 = 0.1\mu\text{F} (Note 2), T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}\text{C.})$

	,						
PARAMETER	SYMBOL	CONDITIONS		MIN	ТҮР	MAX	UNITS
Receiver Positive or Negative Threshold to INVALID High	tinvh	V _{CC} = 5V, Figure	5b		1		μs
Receiver Positive or Negative Threshold to INVALID Low	tinvl	$V_{CC} = 5V$, Figure	5b		30		μs
Receiver or Transmitter Edge to Transmitters Enabled	twu	$V_{CC} = 5V$, Figure	5b		100		μs
RECEIVER INPUTS	1	1		I			1
Input Voltage Range				-25		25	V
Input Threshold Low		T _A = +25°C	$V_{CC} = 3.3V$	0.6	1.2		V
Input Theshold Low		TA = +25 C	$V_{CC} = 5.0V$	0.8	1.5		
Input Threshold High		T _A = +25°C	Vcc = 3.3V		1.5	2.4	- V
input miesnolu nign		TA = +23 C	$V_{CC} = 5.0V$		1.8	2.4	
Input Hysteresis					0.5		V
Input Resistance				3	5	7	kΩ
TRANSMITTER OUTPUTS							
Output Voltage Swing		All transmitter out $3k\Omega$ to ground	puts loaded with	±5	±5.4		V
Output Resistance		$V_{CC} = V_{+} = V_{-} =$	0, $T_{OUT} = \pm 2V$	300	10M		Ω
Output Short-Circuit Current						±60	mA
Output Leakage Current		$V_{OUT} = \pm 12V, V_{C}$ 5.5V, transmitters				±25	μA
MOUSE DRIVEABILITY (MAX3	243E)	1		1			-1
Transmitter Output Voltage		T1IN = T2IN = GND, T3IN = V _{CC} , T3OUT loaded with $3k\Omega$ to GND, T1OUT and T2OUT loaded with 2.5mA each		±5.0			V
ESD PROTECTION	1			1			
		IEC 1000-4-2 Air-	Gap Discharge		±15		
R_IN, T_OUT		IEC 1000-4-2 Cor	ntact Discharge		±8		kV
		Human Body Mod	del		±15		7

TIMING CHARACTERISTICS-MAX3221E/MAX3223E/MAX3243E

 $(V_{CC} = +3.0V \text{ to } +5.5V, C1-C4 = 0.1 \mu F \text{ (Note 2)}, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}C.)$

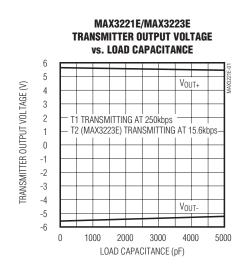
PARAMETER	SYMBOL	CONDITI	ONS	MIN	ТҮР	MAX	UNITS
Maximum Data Rate		$R_L = 3k\Omega$, $C_L = 1000pF$, one transmitter switching		250			kbps
Receiver Propagation Delay	t PHL	C _I = 150pF			0.15		μs
necewer ropagation belay	tplh				0.15		μο
Receiver Output Enable Time		Normal operation		200		ns	
Receiver Output Disable Time		Normal operation		200		ns	
Transmitter Skew	tphl - tplh	(Note 3)		100		ns	
Receiver Skew	tphl - tplh				50		ns
Transition-Region Slew Rate		$\label{eq:VCC} \begin{array}{l} V_{CC} = 3.3V, \\ R_L = 3k\Omega \mbox{ to } 7k\Omega, \\ T_A = +25^\circ C, \\ measured from +3V \\ \mbox{ to } -3V \mbox{ or } \\ -3V \mbox{ to } +3V, \mbox{ one } \\ transmitter \mbox{ switching } \end{array}$	C _L = 150pF to 1000pF	6		30	V/µs

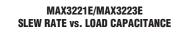
Note 2: $C1-C4 = 0.1\mu$ F, tested at 3.3V ±10%. $C1 = 0.047\mu$ F, $C2-C4 = 0.33\mu$ F, tested at 5.0V ±10%.

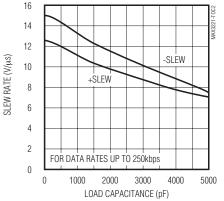
Note 3: Transmitter skew is measured at the transmitter zero cross points.

Typical Operating Characteristics

 $(V_{CC} = +3.3V, 250 \text{kbps} \text{ data rate}, 0.1 \mu \text{F} \text{ capacitors}, all transmitters loaded with 3k} \Omega$ and CL, TA = +25°C, unless otherwise noted.)

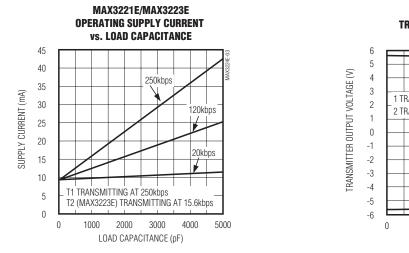


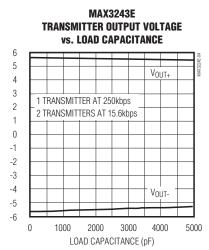


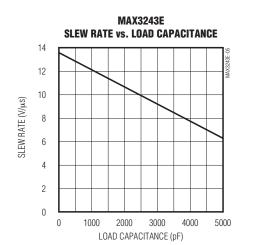


Typical Operating Characteristics (continued)

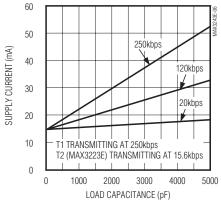
(V_{CC} = +3.3V, 250kbps data rate, 0.1 μ F capacitors, all transmitters loaded with 3k Ω and C_L, T_A = +25°C, unless otherwise noted.)







MAX3243E Operating supply current vs. load capacitance



Pin Description

		Р	IN				
MAX3	3221E	MAX	3223E	MAX	3243E		
TQFN- EP	SSOP/ TSSOP	TQFN- EP	DIP/ SSOP/ TSSOP	SO/ SSOP/ TSSOP	TQFN- EP	NAME	FUNCTION
14	1	19	1		22	ĒN	Receiver Enable Control. Drive low for normal operation. Drive high to force the receiver outputs (R_OUT) into a high-impedance state.
16	2	1	2	28	28	C1+	Positive terminal of the voltage doubler Charge-Pump Capacitor
15	3	20	3	27	27	V+	+5.5V generated by the charge pump
1	4	2	4	24	23	C1-	Negative terminal of the voltage doubler Charge-Pump Capacitor
2	5	3	5	1	29	C2+	Positive terminal of inverting Charge-Pump Capacitor
3	6	4	6	2	30	C2-	Negative terminal of inverting Charge-Pump Capacitor
4	7	5	7	3	31	V-	-5.5V generated by the charge pump
5	8	7, 14	9, 16	4-8	1-5	R_IN	RS-232 Receiver Inputs
6	9	8, 13	10, 15	15-19	13, 14, 15, 17, 18	R_OUT	TTL/CMOS Receiver Outputs
7	10	9	11	21		INVALID	Output of the Valid Signal Detector. INVALID is enabled high if a valid RS-232 level is present on any receiver input.
8	11	10, 11	12, 13	12, 13, 14	10, 11, 12	T_IN	TTL/CMOS Transmitter Inputs
9	12	12	14	23	_	FORCEON	Drive high to override automatic circuitry keeping transmitters and charge pump on (FORCEOFF must be high) (Table 1).
10	13	6, 15	8, 17	9, 10, 11	6, 7, 8	T_OUT	RS-232 Transmitter Outputs
_	_		_	20	19	R2OUTB	TTL/CMOS Noninverting Complementary Receiver Output. Always active.
11	14	16	18	25	24	GND	Ground
12	15	17	19	26	26	V _{CC}	+3.0V to +5.5V Supply Voltage
13	16	18	20	22		FORCEOF F	Force-Off Input, active low. Drive low to shut down transmitters, receivers (MAX3243E, except R2OUTB), and on-board charge pump. This overrides all automatic circuitry and FORCEON (Table 1).
_			_	_	21	SHDN	Shutdown Control, Active Low

Pin Description (continued)

		Р	IN				
MAX3	MAX3221E		3223E	MAX3	243E		
TQFN- EP	SSOP/ TSSOP	TQFN- EP	DIP/ SSOP/ TSSOP	SO/ SSOP/ TSSOP	TQFN- EP	NAME	FUNCTION
_	_	—	_	—	19, 20	R_OUTB	Noninverting Complementary Receiver Outputs. Always active.
_		_	_	_	9, 16, 25, 32	N.C.	No Connection. Not internally connected.
			_			EP	Exposed Paddle (TQFN package only). Solder the exposed paddle to the ground plane or leave unconnected.

Detailed Description

Dual Charge-Pump Voltage Converter

The MAX3221E/MAX3223E/MAX3243E's internal power supply consists of a regulated dual charge pump that provides output voltages of +5.5V (doubling charge pump) and -5.5V (inverting charge pump), over the +3.0V to +5.5V V_{CC} range. The charge pumps operate in discontinuous mode: if the output voltages are less than 5.5V, the charge pumps are enabled; if the output voltages exceed 5.5V, the charge pumps are disabled. Each charge pump requires a flying capacitor (C1, C2) and a reservoir capacitor (C3, C4) to generate the V+ and V- supplies.

RS-232 Transmitters

The transmitters are inverting level translators that convert CMOS-logic levels to 5.0V EIA/TIA-232 levels. They guarantee a 250kbps data rate with worst-case loads of $3k\Omega$ in parallel with 1000pF, providing compatibility with PC-to-PC communication software such as LapLinkTM. Transmitters can be paralleled to drive multiple receivers. The MAX3243E has been specifically designed to drive serial mice. Figure 1 shows a complete system connection. When FORCEOFF is driven to ground, or the AutoShutdown circuitry senses invalid voltage levels on all receiver inputs, the transmitters are disabled and the outputs are forced into a high-impedance state. When powered off or shut down, the output can be driven up to ±12V. The transmitter inputs do not have pull-up resistors.

LapLink is a trademark of Traveling Software.

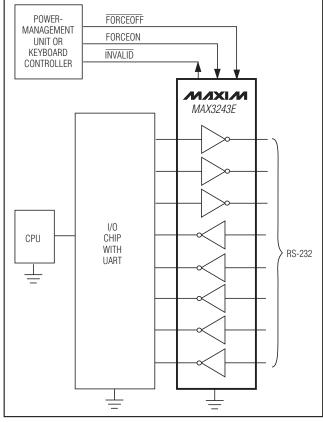


Figure 1. Interface Under Control of PMU

RS-232 Receivers

The MAX3221E/MAX3223E/MAX3243E's receivers convert RS-232 signals to CMOS-logic output levels. All receivers have inverting three-state outputs and can be active or inactive. In shutdown (FORCEOFF = low) or in AutoShutdown, the MAX3221E/MAX3223E's receivers are active (Table 1). Drive EN high to place the receiver(s) in a high-impedance state. The MAX3243E's receivers are high-impedance when the part is in shutdown (FORCEOFF = low).

The MAX3243E features an extra, always-active complementary output (R2OUTB). R2OUTB monitors receiver activity while the other receivers are highimpedance. This allows Ring Indicator to be monitored without forward biasing other devices connected to the receiver outputs. This is ideal for systems where V_{CC} drops to 0 in shutdown to accommodate peripherals such as UARTs (Figure 2).

The MAX3221E/MAX3223E/MAX3243E feature an INVALID output that is enabled low when no valid RS-232 signal levels have been detected on all receiver inputs. INVALID is functional in any mode (Figures 3 and 5).

AutoShutdown

The MAX3221E/MAX3223E/MAX3243E achieve a 1 μ A supply current with Maxim's new AutoShutdown feature, which operates when FORCEON is low and FORCEOFF is high. When these devices sense no valid signal levels on all receiver inputs for 30 μ s, the onboard charge pump and drivers are shut off, reducing supply current to 1 μ A. This occurs if the RS-232 cable is disconnected or the connected peripheral transmitters are turned off. The device turns on again when a valid level is applied to any RS-232 receiver input. As a result, the system saves power without changes to the existing BIOS or operating system.

Table 2 and Figure 3c summarize the MAX3221E/ MAX3223E/MAX3243E operating modes. FORCEON and FORCEOFF override AutoShutdown. When neither control is asserted, the IC selects between these states automatically, based on receiver input levels. Figures 3a, 3b, and 5a depict valid and invalid RS-232 receiver levels. Figure 5 shows the input levels and timing diagram for AutoShutdown operation.

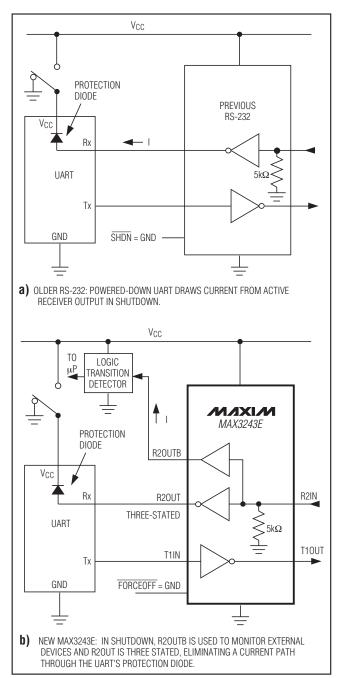


Figure 2. The MAX3243E detects RS-232 activity when the UART and interface are shut down.

OPERATION STATUS	FORCEON	FORCEOFF	EN (MAX3221E/ MAX3223E)	VALID RECEIVER LEVEL	T_OUT	R_OUT (MAX3221E/ MAX3223E)	R_OUT (MAX3243E)	R2OUTB (MAX3243E)
Shutdown	Х	0	0	Х	High-Z	Active	High-Z	Active
(Forced Off)	Х	0	1	Х	High-Z	High-Z	High-Z	Active
Normal Operation	1	1	0	Х	Active	Active	Active	Active
(Forced On)	1	1	1	Х	Active	High-Z	Active	Active
Normal Operation	0	1	0	Yes	Active	Active	Active	Active
(AutoShutdown)	0	1	1	Yes	Active	High-Z	Active	Active
Shutdown	0	1	0	No	High-Z	Active	Active	Active
(AutoShutdown)	0	1	1	No	High-Z	High-Z	Active	Active

Table 1. Output Control Truth Table

X = Don't Care

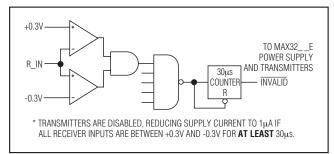


Figure 3a. MAX32__E Entering 1µA Supply Mode via AutoShutdown

A mouse or other system with AutoShutdown may need time to wake up. Figure 4 shows a circuit that forces the transmitters on for 100ms, allowing enough time for the other system to realize that the MAX3221E/ MAX3223E/ MAX3243E are awake. If the other system transmits valid RS-232 signals within that time, the RS-232 ports on both systems remain enabled.

When shut down, the device's charge pumps are off, V+ is pulled to V_{CC}, V- is pulled to ground, and the transmitter outputs are high impedance. The time required to exit shutdown is typically 100 μ s (Figure 5b).

Software-Controlled Shutdown

If direct software control is desired, INVALID can be used to indicate DTR or Ring Indicator signal. Connect FORCEOFF and FORCEON together to disable Auto-Shutdown so the line acts like a SHDN input.

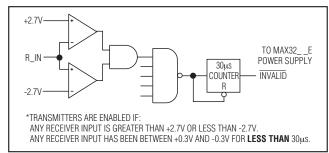
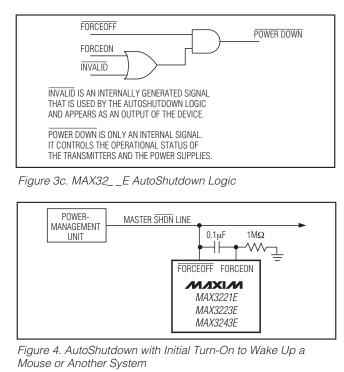


Figure 3b. MAX32_E with Transmitters Enabled Using AutoShutdown

±15kV ESD Protection

As with all Maxim devices, ESD-protection structures are incorporated on all pins to protect against electrostatic discharges encountered during handling and assembly. The driver outputs and receiver inputs of the MAX3221E/MAX3223E/MAX3243E have extra protection against static electricity. Maxim's engineers have developed state-of-the-art structures to protect these pins against ESD of ±15kV without damage. The ESD structures withstand high ESD in all states: normal operation, shutdown, and powered down. After an ESD event, Maxim's E versions keep working without latchup, whereas competing RS-232 products can latch and must be powered down to remove latchup. See Table 4.



ESD protection can be tested in various ways; the transmitter outputs and receiver inputs of this product family are characterized for protection to the following limits:

- 1) ±15kV using the Human Body Model
- 2) ±8kV using the Contact Discharge Method specified in IEC1000-4-2
- 3) ±15kV using IEC1000-4-2's Air-Gap Method

ESD Test Conditions

ESD performance depends on a variety of conditions. Contact Maxim for a reliability report that documents test setup, test methodology, and test results.

Human Body Model

Figure 6a shows the Human Body Model, and Figure 6b shows the current waveform it generates when discharged into a low impedance. This model consists of a 100pF capacitor charged to the ESD voltage of interest, which is then discharged into the test device through a $1.5 \mathrm{k}\Omega$ resistor.

IEC1000-4-2

The IEC1000-4-2 standard covers ESD testing and performance of finished equipment; it does not specifically refer to integrated circuits. The MAX3221E/ MAX3223E/ MAX3243E help you design equipment that meets

Table 2. INVALID Truth Table

RS-232 SIGNAL PRESENT AT ANY RECEIVER INPUT	INVALID OUTPUT
Yes	High
No	Low

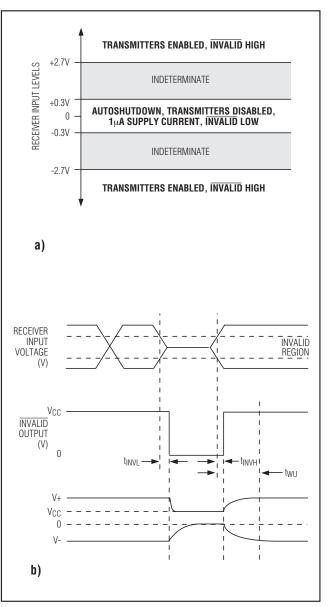


Figure 5. AutoShutdown Trip Levels



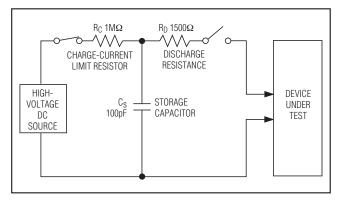


Figure 6a. Human Body ESD Test Models

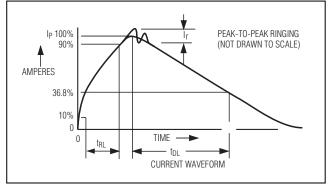


Figure 6b. Human Body Model Current Waveform

Level 4 (the highest level) of IEC1000-4-2, without the need for additional ESD-protection components.

The major difference between tests done using the Human Body Model and IEC1000-4-2 is higher peak current in IEC1000-4-2, because series resistance is lower in the IEC1000-4-2 model. Hence, the ESD withstand voltage measured to IEC1000-4-2 is generally lower than that measured using the Human Body Model. Figure 7a shows the IEEE1000-4-2 model and Figure 7b shows the current waveform for the ±8kV IEC1000-4-2 Level 4 ESD contact-discharge test.

The air-gap test involves approaching the device with a charged probe. The contact-discharge method connects the probe to the device before the probe is energized.

Machine Model

The Machine Model for ESD tests all pins using a 200pF storage capacitor and zero discharge resistance. Its objective is to emulate the stress caused by contact that occurs with handling and assembly during manufacturing. Of course, all pins require this protection during manufacturing, not just RS-232 inputs and outputs.

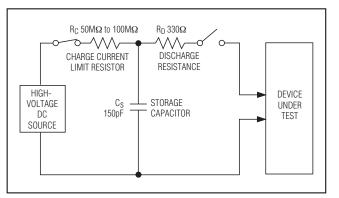


Figure 7a. IEC1000-4-2 ESD Test Model

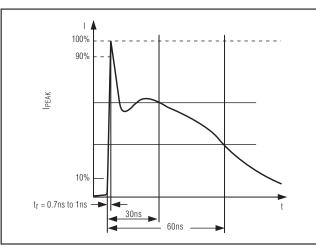


Figure 7b. IEC1000-4-2 ESD Generator Current Waveform

Therefore, after PC board assembly, the Machine Model is less relevant to I/O ports.

Applications Information Capacitor Selection

The capacitor type used for C1–C4 is not critical for proper operation; either polarized or nonpolarized capacitors may be used. The charge pump requires 0.1µF capacitors for 3.3V operation. For other supply voltages, refer to Table 3 for required capacitor values. Do not use values smaller than those listed in Table 3. Increasing the capacitor values (e.g., by a factor of 2) reduces ripple on the transmitter outputs and slightly reduces power consumption. C2, C3, and C4 can be increased without changing C1's value. However, do not increase C1 without also increasing the values of C2, C3, and C4 to maintain the proper ratios (C1 to the other capacitors).



MAX3221 E/MAX3223E/MAX3243E

When using the minimum required capacitor values, make sure the capacitor value does not degrade excessively with temperature. If in doubt, use capacitors with a larger nominal value. The capacitor's equivalent series resistance (ESR) usually rises at low temperatures and influences the amount of ripple on V+ and V-.

Power-Supply Decoupling

In most circumstances, a 0.1μ F V_{CC} bypass capacitor is adequate. In applications that are sensitive to powersupply noise, use a capacitor of the same value as the charge-pump capacitor C1. Connect bypass capacitors as close to the IC as possible.

Transmitter Outputs when Exiting Shutdown

Figure 8 shows two transmitter outputs when exiting shut down mode. As they become active, the two transmitter outputs are shown going to opposite RS-232 levels (one transmitter output is high, the other is low). Each transmitter is loaded with $3k\Omega$ in parallel with 1000pF. The transmitter outputs display no ringing or undesirable transients as they come out of shutdown, and are enabled only when the magnitude of V-exceeds approximately -3V.

High Data Rates

The MAX3221E/MAX3223E/MAX3243E maintain the RS-232 ±5.0V minimum transmitter output voltage even at high data rates. Figure 9 shows a transmitter loopback test circuit. Figure 10 shows a loopback test result at 120kbps, and Figure 11 shows the same test at 250kbps. For Figure 10, all three transmitters were driven simultaneously at 120kbps into RS-232 loads in parallel with 1000pF. For Figure 11, a single transmitter was driven at 250kbps, and all three transmitters were loaded with an RS-232 receiver in parallel with 1000pF.

Mouse Driveability (MAX3243E)

The MAX3243E has been specifically designed to power serial mice while operating from low-voltage power supplies. It has been tested with leading mouse brands such

Table 3. Required Capacitor Values

V _{CC} (V)	C1, C _{BYPASS} (µF)	C2, C3, C4 (µF)
3.0 to 3.6	0.22	0.22
3.15 to 3.6	0.1	0.1
4.5 to 5.5	0.047	0.33
3.0 to 5.5	0.22	1

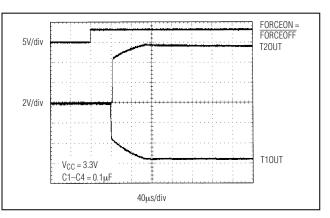


Figure 8. Transmitter Outputs Exiting Shutdown or Powering Up

as Logitech and Microsoft. When tested, the MAX3243E successfully drove all serial mice and met their respective current and voltage requirements. The MAX3243E's regulated dual charge pump ensures the transmitters will supply at least ±5V during worst-case conditions. Figure 12a shows the transmitter outputs under increasing load current. The AutoShutdown feature does not work with a mouse, so FORCEOFF and FORCEON should be connected to V_{CC}. Figure 12b (on the following page) shows a mouse driver test circuit. To achieve mouse driveability with 1µA supply current when the port is inactive, use parts with the AutoShutdown Plus[™] feature (such as the MAX3244E and MAX3245E).

AutoShutdown Plus is a trademark of Maxim Integrated Products, Inc.

MAX3221E/MAX3223E/MAX3243E

Table 4. ±15kV ESD-Protected, 3.0V to 5.5V Powered RS-232 Transceivers from Maxim

PART	SUPPLY VOLTAGE RANGE (V)	NO. OF Tx/Rx	SUPPLY CURRENT (µA)	Auto- Shutdown Plus	Auto- Shutdown	HUMAN BODY MODEL (kV)	IEC 1000-4-2 CONTACT DISCHARGE (kV)	IEC 1000-4-2 AIR-GAP DISCHARGE (kV)	GUARANTEED DATA RATE (kbps)
MAX3241E	+3.0 to +5.5	3/5	300	—		±15	±8	±15	250
MAX3243E	+3.0 to +5.5	3/5	1	—	Yes	±15	±8	±15	250
MAX3244E	+3.0 to +5.5	3/5	1	Yes	_	±15	±8	±15	250
MAX3245E	+3.0 to +5.5	3/5	1	Yes		±15	±8	±15	1Mbps
MAX3232E	+3.0 to +5.5	2/2	300		_	±15	±8	±15	250
MAX3222E	+3.0 to +5.5	2/2	300	_		±15	±8	±15	250
MAX3223E	+3.0 to +5.5	2/2	1		Yes	±15	±8	±15	250
MAX3224E	+3.0 to +5.5	2/2	1	Yes		±15	±8	±15	250
MAX3225E	+3.0 to +5.5	2/2	1	Yes		±15	±8	±15	1Mbps
MAX3221E	+3.0 to +5.5	1/1	1		Yes	±15	±8	±15	250
MAX3226E	+3.0 to +5.5	1/1	1	Yes		±15	±8	±15	250
MAX3227E	+3.0 to +5.5	1/1	1	Yes		±15	±8	±15	1Mbps

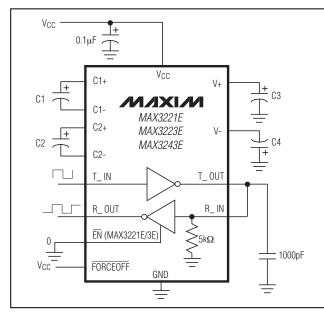


Figure 9. Loopback Test Circuit

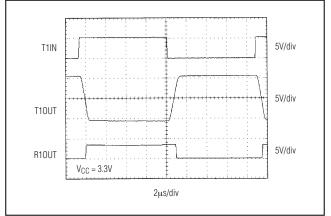


Figure 10. Loopback Test Result at 120kbps

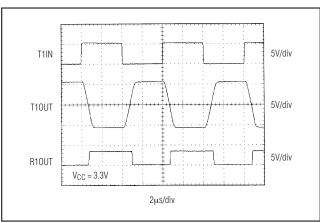


Figure 11. Loopback Test Result at 250kbps

Various Supply Voltages

SYSTEM

POWER-SUPPLY

VOLTAGE

(V)

3.3

5

5

Table 5. Logic Family Compatibility with

V_{CC} SUPPLY

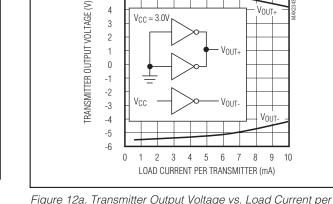
VOLTAGE

(V)

3.3

5

3.3



VOUT

6 5

4

Transmitter

	-	-
PART	TEMP RANGE	PIN-PACKAGE

Ordering Information (continued)

PART	TEMP RANGE	PIN-PACKAGE
MAX3243ECWI+	0°C to +70°C	28 Wide SO
MAX3243ECAI+	0°C to +70°C	28 SSOP
MAX3243ECUI+	0°C to +70°C	28 TSSOP
MAX3243EEWI+	-40°C to +85°C	28 Wide SO
MAX3243EEAI+	-40°C to +85°C	28 SSOP
MAX3243EEUI+	-40°C to +85°C	28 TSSOP
MAX3243ECTJ+	0°C to +70°C	32 TQFN-EP*
MAX3243EETJ+	-40°C to +85°C	32 TQFN-EP*

*Exposed pad.

+Denotes a lead(Pb)-free/RoHS-compliant package.

Interconnection with 3V and 5V Logic

families.

COMPATIBILITY

Compatible with all CMOS

Compatible with all TTL and

Incompatible with AC, HC,

CMOS-logic families. Compatible with ACT and HCT CMOS, and with TTL.

or CD4000 CMOS.

The MAX3221E/MAX3223E/MAX3243E can directly interface with various 5V logic families, including ACT and xHCT CMOS. See Table 5 for more information on possible combinations of interconnections.

Chip Information

PROCESS: BICMOS

M/IXI/M

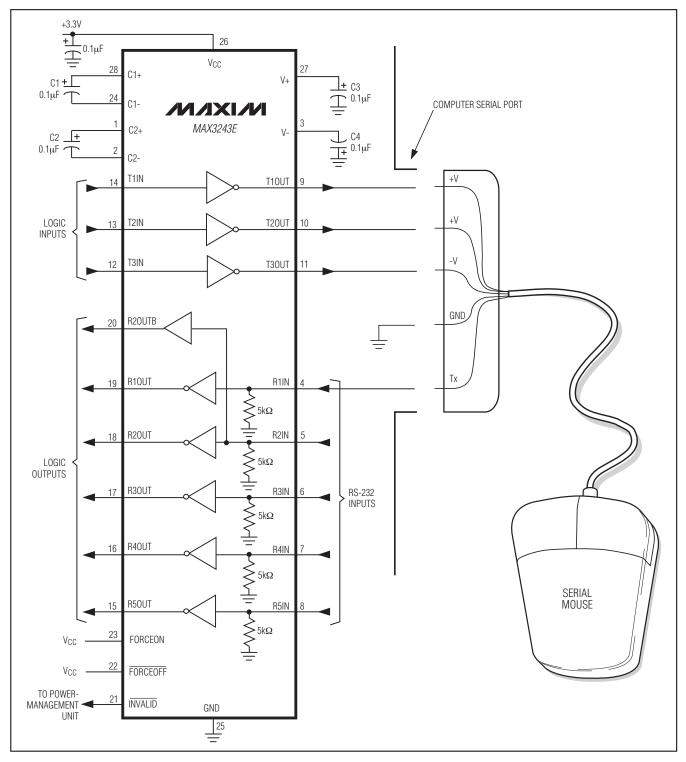
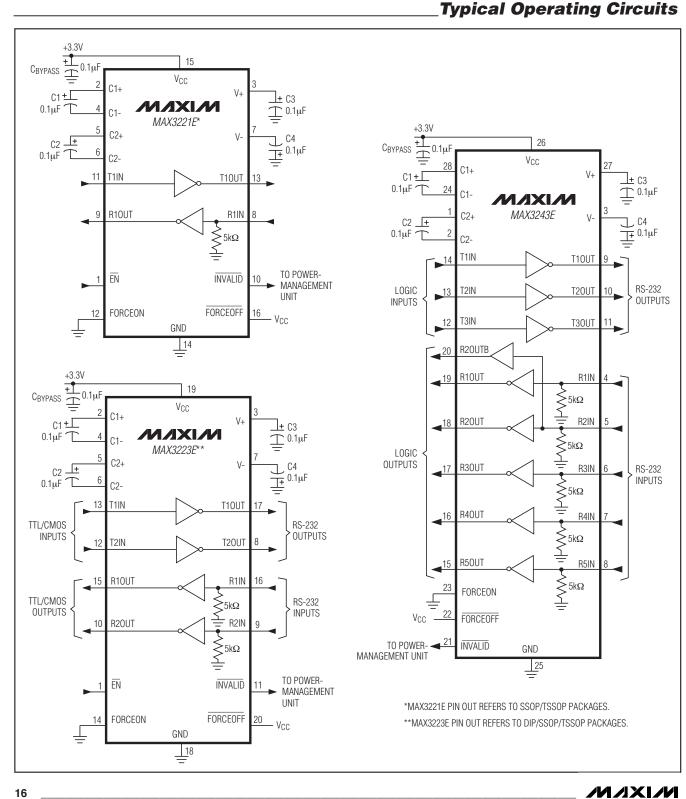


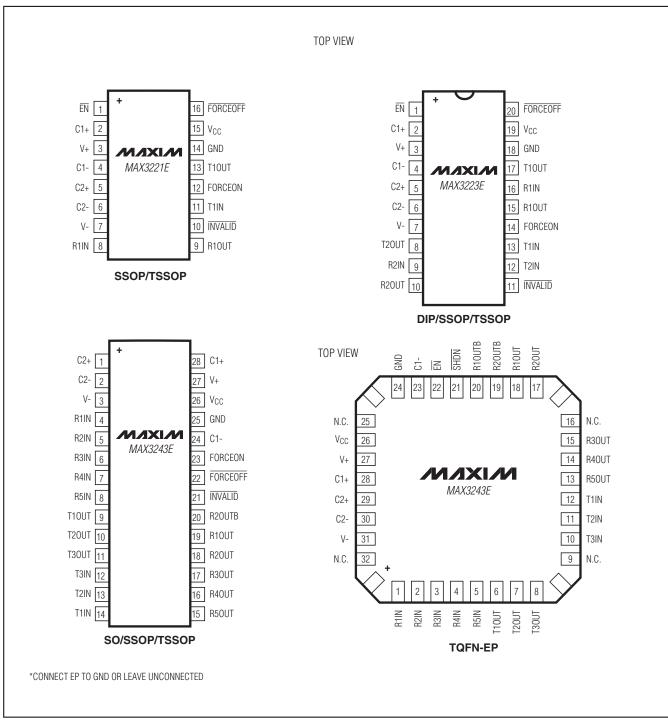
Figure 12b. Mouse Driver Test Circuit

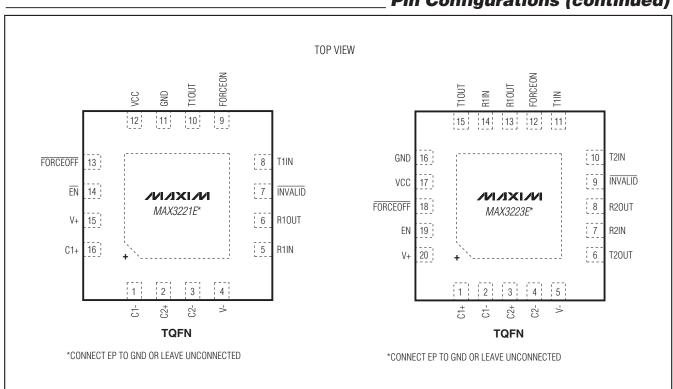




MAX3221E/MAX3223E/MAX3243E

Pin Configurations





Pin Configurations (continued)

Package Information

For the latest package outline information and land patterns (footprints), go to <u>www.maxim-ic.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
16 TQFN-EP	T1655+2	<u>21-0140</u>	<u>90-0072</u>
16 SSOP	A16+2	<u>21-0056</u>	<u>90-0106</u>
16 TSSOP	U16+1	<u>21-0066</u>	<u>90-0117</u>
20 TQFN-EP	T2055+5	<u>21-0140</u>	<u>90-0010</u>
20 SSOP	A20+2	<u>21-0056</u>	<u>90-0094</u>
20 TSSOP	U20+2	<u>21-0066</u>	<u>90-0116</u>
20 PDIP	P20+3	<u>21-0043</u>	—
28 Wide SO	W28+6	<u>21-0042</u>	<u>90-0109</u>
28 SSOP	A28+1	<u>21-0056</u>	<u>90-0095</u>
28 TSSOP	U28+2	<u>21-0066</u>	<u>90-0171</u>
32 TQFN-EP	T3277+2	<u>21-0144</u>	<u>90-0125</u>

Revision History

REVISION	REVISION	DESCRIPTION	PAGES
NUMBER	DATE		CHANGED
7	8/11	Added MAX3223EEUP/V+ automotive qualified part and updated <i>Ordering Information</i> to show lead-free versions	1, 2, 14, 17, 18

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Analog Devices Inc.:

MAX3221ECAE+ MAX3221ECTE+ MAX3221EEAE+ MAX3223ECAP+ MAX3223ECUP+ MAX3223EEAP+ MAX3223EEPP+ MAX3223EETP+ MAX3223EEUP+ MAX3243EEAI+ MAX3243EEUI+ MAX3221ECAE+T MAX3221ECTE+T MAX3221ECUE+ MAX3221ECUE+T MAX3221EEAE+T MAX3221EETE+ MAX3221EETE+T MAX3221EEUE+ MAX3221EEUE+T MAX3223ECAP+T MAX3223ECPP+ MAX3223ECTP+ MAX3223ECTP+T MAX3223ECUP+T MAX3223EEAP+T MAX3223EETP+T MAX3223EEUP+T MAX3243EEAI+T MAX3243EEUI+T MAX3243EEWI+ MAX3243EEWI+T MAX3243EETJ+ MAX3243EETJ+T MAX13221EETE+ MAX13221EETE+T